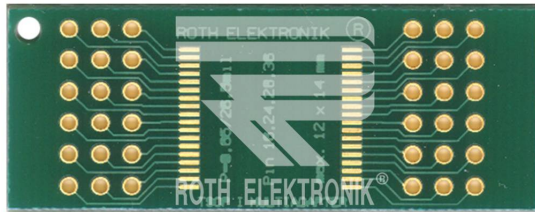


Adapter TSOP I



RE900-04

- FR4 EPOXY fibre-glass FR4 1.50 mm double-sided 35 µm CU (pth)
- solder and component side with chemical Ni/AU surface and solder stop mask
- pitch spacings:
0.65 mm (26.5 mil)
- Pins:
16, 24, 28, 36
- hole dia Ø 1.00 mm
- Gerber data for manufacture of the soldering paste imprint will be provided free of charge on request
- size: 43.5 x 16.5 mm